SHROUDED AND EJECTOR IDC HEADER

(1.27 mm) .050" PITCH • SHF/ESHF/EHF/ECF SERIES

SHF/ESHF

Mates:

FFSD, FFTP (SHF)

EHF

Mates:

FFSD*, FFTP

*Important Note:

EHF will not mate to FFSD with strain relief (-SR option), see ESHF series.

SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze Plating:

Sn or Au over 50 μ" (1.27 μm) Ni Operating Temp Range: -55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max

SERIES

SHF

Mates with

FFSD without

Strain Relief

ESHF

= Mates with

FFSD with

Strain Relief

(5.33)

.210

NO. PINS PER ROW

04, 05, 06,

08, 10, 11,

12, 13, 15,

17, 20, 25

(Standard sizes)

-TH



PLATING OPTION

= 10 µ" (0.25 µm)

Gold on

post, Matte

Tin

on tail

-SM



OPTION

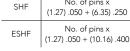
-TH = Through-

hole -RA = Right-angle

-SM

= Surface Mount

TYPE STRIP Α No. of pins x SHE





OPTION

OTHER

-LC = Locking Clip (Not available with -RA) (Manual placement required)

-K = (6.50 mm) .256" DIA Polyimide Film Pick& Place Pad (-SM only)

-TR = Tape & Reel

-FRFull Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)

IJIJ

-TH

NO. PINS **PER ROW**



-RA

PLATING OPTION



-SM

TAIL **OPTION**

-RA

OTHER OPTION

-"XX"

= Polarized Position

(-RA not available)

-LC

= Locking Clip

(–SM only) (Manual placement

required)

-K = (7.50 mm) .295" DIA

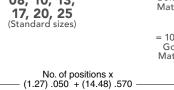
EJECTOR HEADER CAP (8.71) (9.70) No. of positions x (1.27) .050 → + (18.16) .715

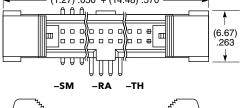
05, 08, 10, 13, 17, 20, 25

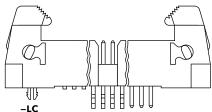
NO. PINS PER ROW

04, 05, 08, 10, 13, 17, 20, 25







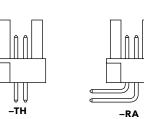


-F









Leave blank for Through-hole version

-SM = Surface Mount

-RA = Right-angle



Polyimide Film Pick & Place Pad -P

= Pick & Place Pad (–SM only)

= Tape & Reel (-LC not available)



Note:

Some lengths, styles and options are non-standard, non-returnable.